

[54] **EARPHONE**

[75] **Inventor: Takefumi Daido, Tokyo, Japan**

[73] **Assignee: Sony Corporation, Tokyo, Japan**

[**] **Term: 14 Years**

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[58] **Field of Search** D14/205, 206, 207, 223;
379/430, 444; 381/25, 68, 158, 183, 187;
181/129, 135

[56] **References Cited**

U.S. PATENT DOCUMENTS

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[57] **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a front elevational view of an earphone, showing my new design;
FIG. 2 is a rear elevational view thereof;
FIG. 3 is a left-side elevational view thereof;
FIG. 4 is a right-side elevational view thereof;
FIG. 5 is a top plan view thereof; and
FIG. 6 is a bottom plan view thereof.

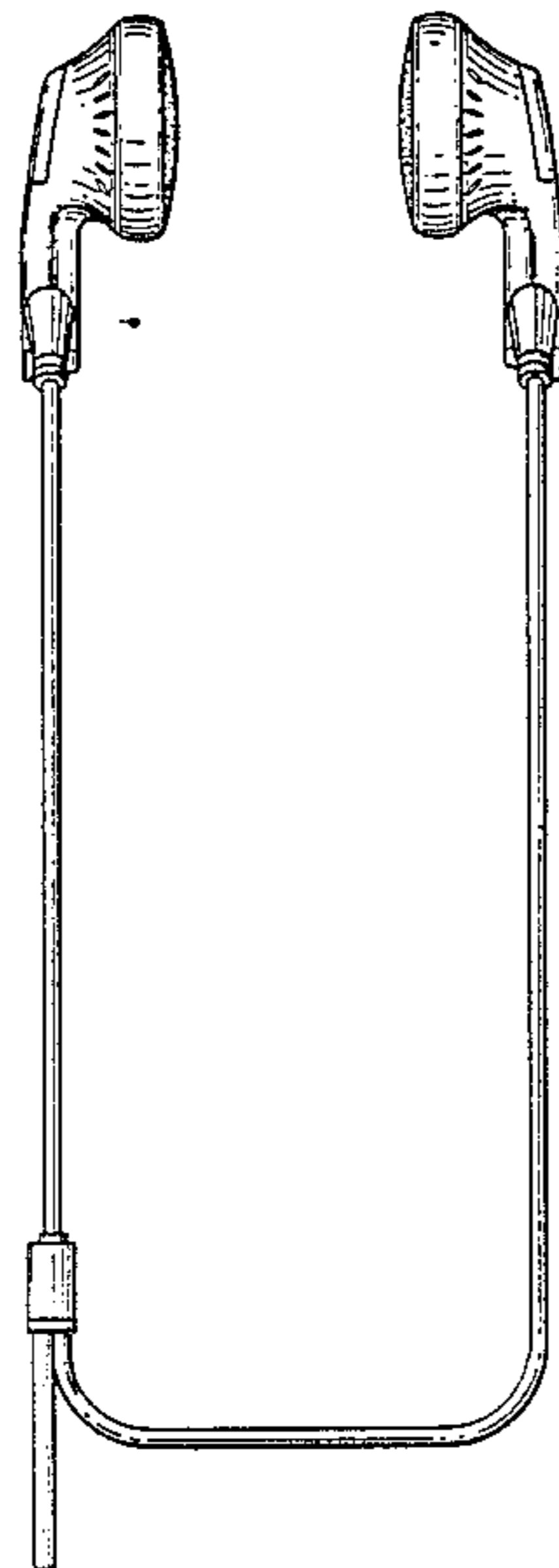


FIG. 1

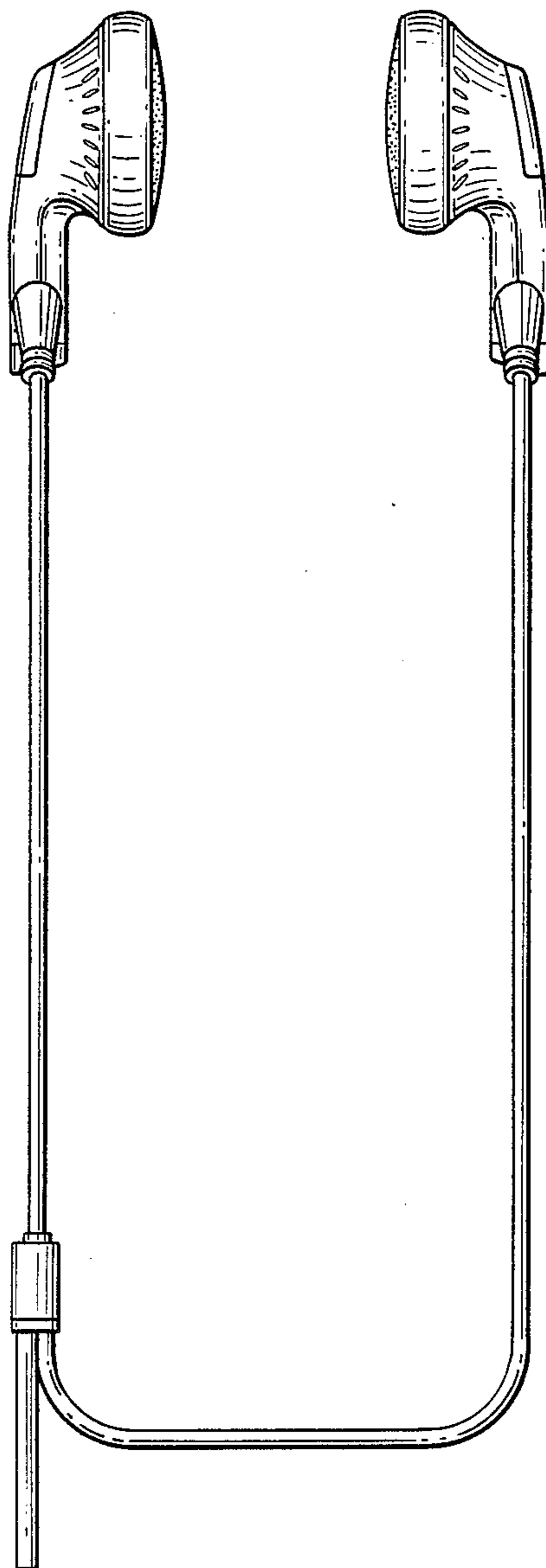


FIG. 2

